

Part No.

AL-50-30SUG5C

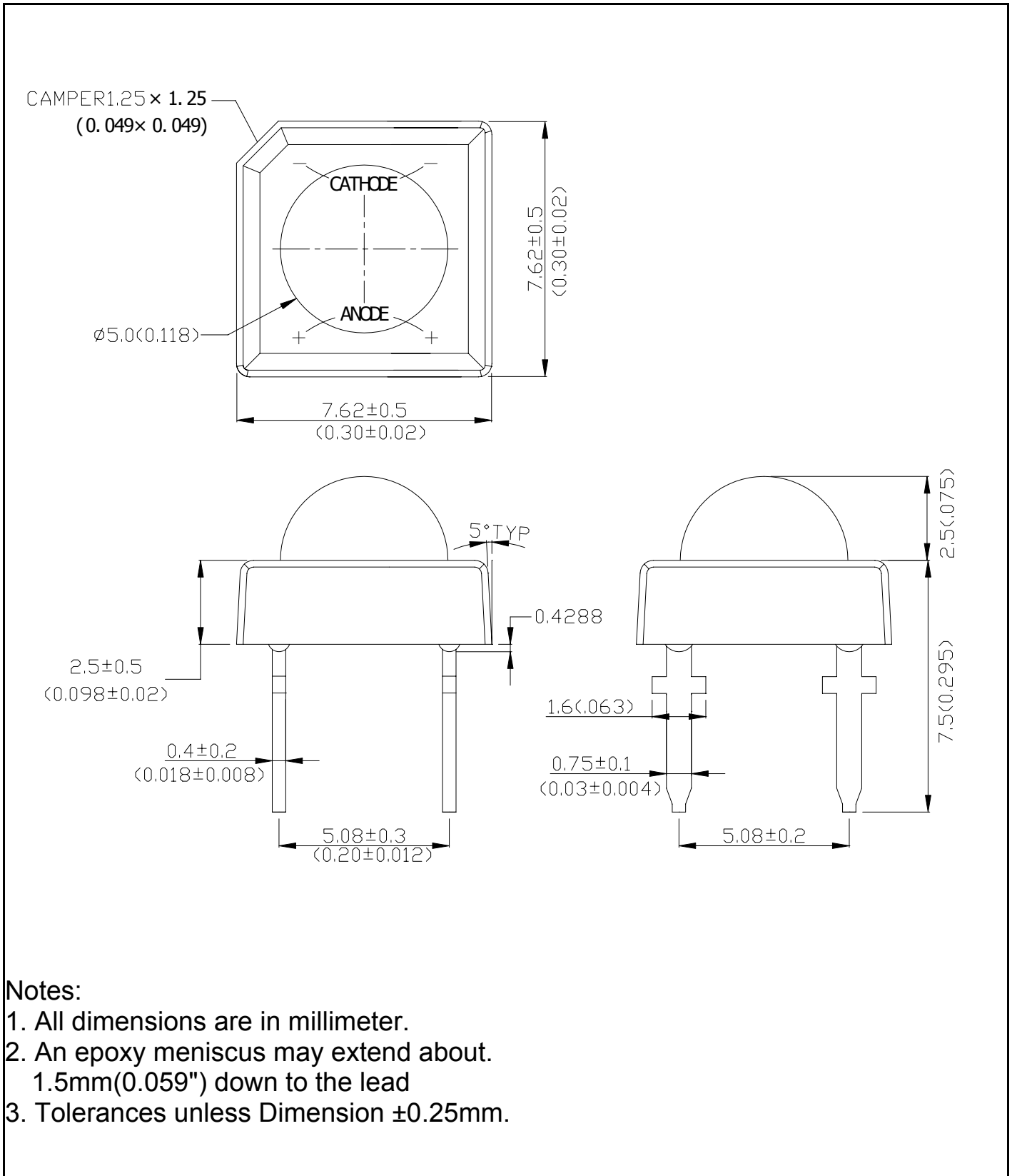
Diff No.

5 mm

High Power

Type : LED Lamps

■ Package Dimension:



Notes:

1. All dimensions are in millimeter.
2. An epoxy meniscus may extend about 1.5mm(0.059") down to the lead
3. Tolerances unless Dimension ± 0.25 mm.

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LED Parts P/N.	Chip		Lens Color
	Material	Emitted Color	
AL-50-30SUG5C	InGaN	Super Green	Water Clear

■ Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I _F	30	mA
Operating Temperature	T _{opr}	-30 to +80	°C
Storage Temperature	T _{stg}	-40 to +100	°C
Soldering Temperature	T _{sol}	260 ± 5	°C
Electrostatic Discharge	ESD	1000	V
Power Dissipation	P _D	120	mW
Peak Forward Current (Duty 1/10@1KHz)	I _F (Peak)	100	mA
Reverse Voltage	V _R	5	V

■ Electronic Optical Characteristics :

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	/	3500	/	mcd	I _F =20mA
Viewing Angle	2θ 1/2	/	60	/	deg	---
Peak Wavelength	λ _p	/	530	/	nm	I _F =20mA
Dominant Wavelength	λ _d	/	525	/	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ	/	30	/	nm	I _F =20mA
Forward Voltage	V _F	/	3.2	4.0	V	I _F =20mA
Reverse Current	I _R	/	/	50	μA	V _R =5V

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■ Reliability test items and conditions :

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

NO	ITEM	Test Conditions	Test hours/cycle	Sample Q'ty	Ac/Re
1	Solder Heat	Temp : 260°C±5°C	5 sec	80 pcs	0/1
2	Temperature Cycle	H : +85°C 30min λ 5min L : -40°C 30min	100 cycles	80 pcs	0/1
3	Thermal Shock	H : +100°C 5min λ 10sec L : -10°C 5min	100 cycles	80 pcs	0/1
4	High Temperature Storage	Ta=100°C	1000 hrs	80 pcs	0/1
5	Low Temperature Storage	Ta=-40°C	1000 hrs	80 pcs	0/1
6	DC Operating Life	Temp : 25°C I _F =20mA	1000 hrs	80 pcs	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 hrs	80 pcs	0/1

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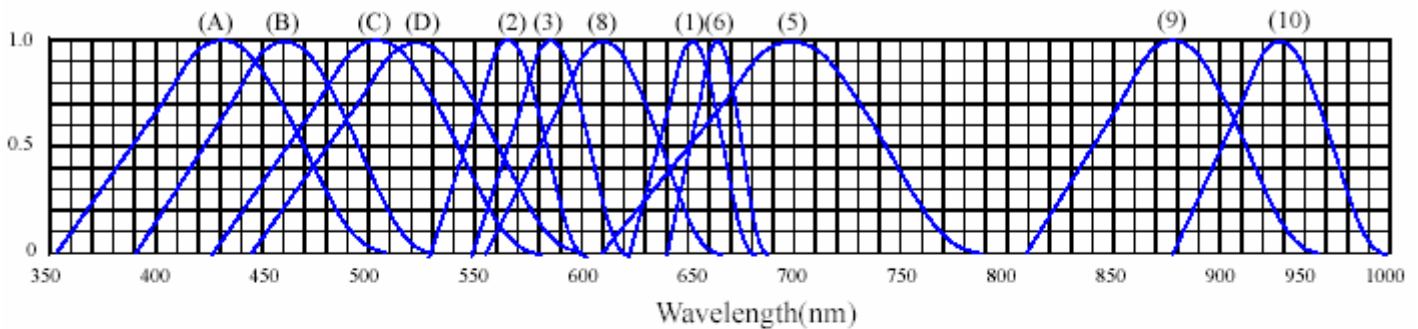
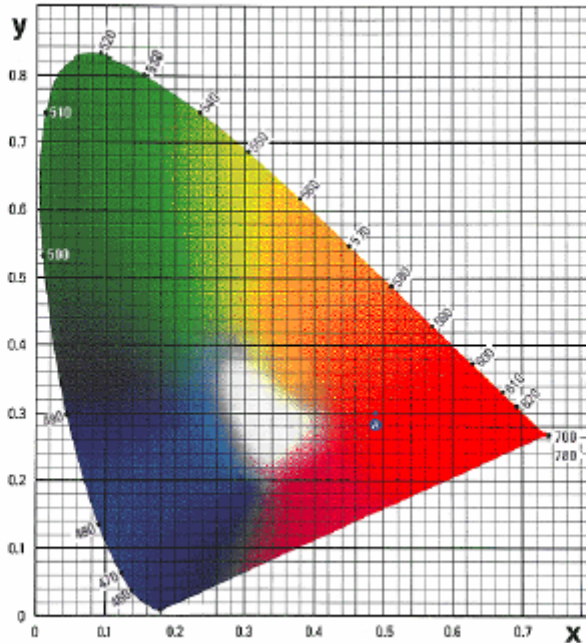
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◆ TYPICAL ELECTRICAL-OPTICAL CHARACTERISTICS CURVES



RELATIVE INTENSITY VS. WAVELENGTH(λ_p)

- | | |
|---|----------------------------------|
| (1) GaAsP/GaAs 655nm/Red | (9)- GaAlAs 880nm |
| (2) GaP 568nm/ Yellow Green | (10)-GaAs/GaAs&GaAlAs/GaAs 940nm |
| (3) GaAsP/GaP 585nm/Yellow | (A)- GaN 430nm/Blue |
| (4) GaAsP/GaP 635nm/Orange & Hi-Eff Red | (B)- InGaN 470nm/Blue |
| (5) GaP 700nm/Bright Red | (C)- InGaN 502nm/Ultra Green |
| (6) GaAlAs/GaAs 660nm/Super Red | (D)- InGaN 523nm/Ultra Green |
| (8) GaAsP/GaP 610nm/Super Red | |

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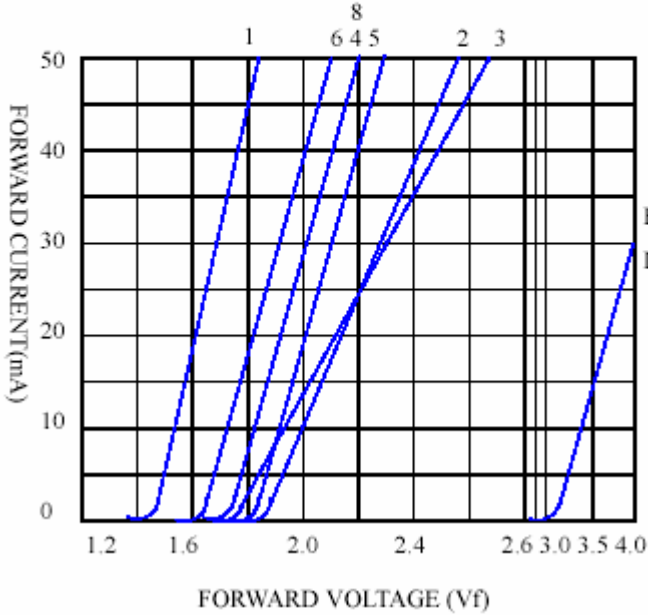
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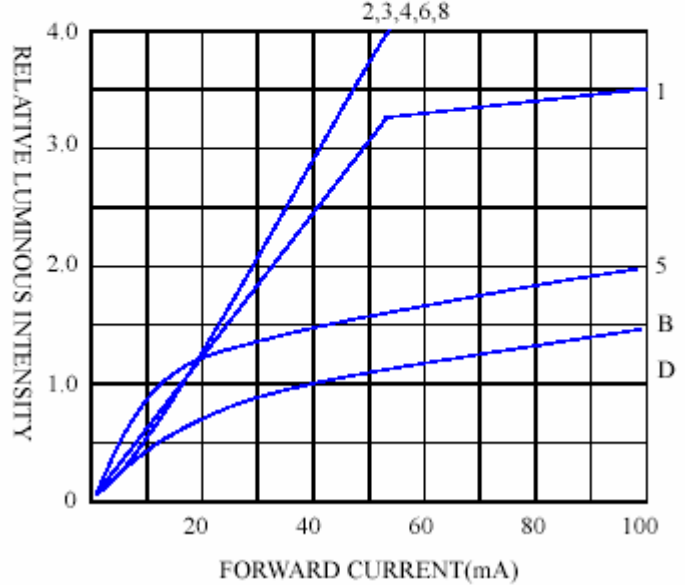
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◆ CHARACTERISTICS DIAGRAMS

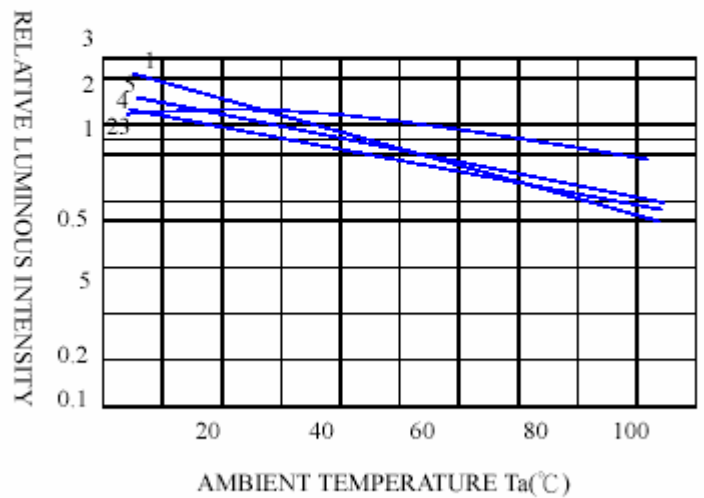
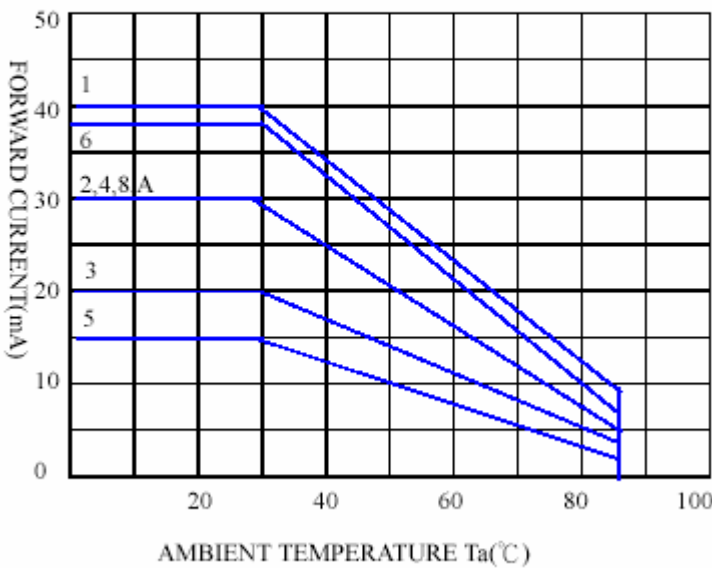
FORWARD CURRENT VS. FORWARD VOLTAGE



RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT



FORWARD CURRENT VS. AMBIENT TEMPERATURE



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Precautions For Use

1. Over-current proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

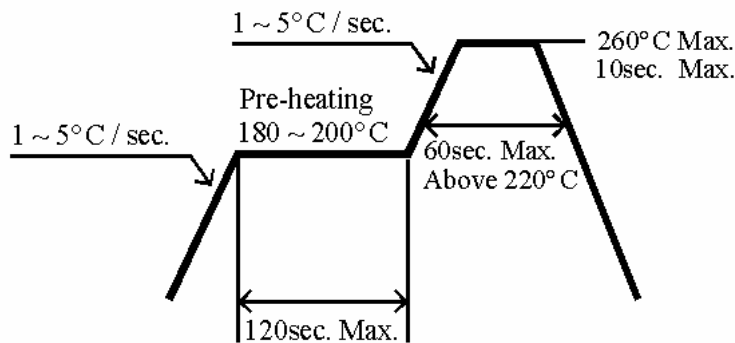
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.